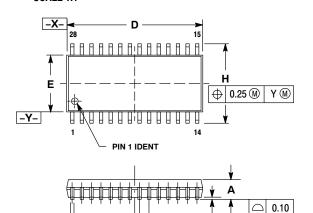
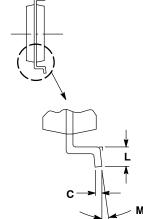


SOIC-28 WB CASE 751F ISSUE J

DATE 23 SEP 2015







NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- 2. CONTROLLING DIMENSION: MILLIMETER.
 3. DIMENSIONS D AND E DO NOT INCLUDE MOLD PROTRUSION
 MAXIMUM MOLD PROTRUSION 0.15 PER SIDE.
- MAXIMUM MOLD PROTRUSION 0.15 PER SIDE.
 DIMENSION B DOES NOT INCLUDE DAMBAR
 PROTRUSION. ALLOWABLE DAMBER
 PRSOTRUSION SHALL NOT BE 0.13 TOTATL IN
 EXCESS OF B DIMENSION AT MAXIMUM
 MATERIAL CONDITION MATERIAL CONDITION.

	MILLIMETERS	
DIM	MIN	MAX
Α	2.35	2.65
A1	0.13	0.29
В	0.35	0.49
С	0.23	0.32
D	17.80	18.05
Е	7.40	7.60
G	1.27 BSC	
Н	10.05	10.55
Ĺ	0.41	0.90
M	0°	8°

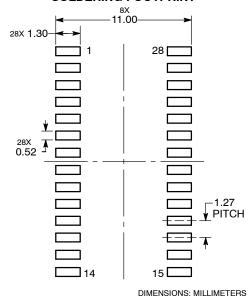
SOLDERING FOOTPRINT

 $| \bigoplus |$ 0.025 M | T | X S | YS

G

-T-

SEATING PLANE



GENERIC MARKING DIAGRAM*



XXXXX = Specific Device Code = Assembly Location

WL = Wafer Lot Υ = Year WW = Work Week = Pb-Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ■", may or may not be present.

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DESCRIPTION:	SOIC-28 WIDE BODY		PAGE 1 OF 1

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